TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3506

Relay Drive and DC-DC Converter Applications Motor Drive Applications

- Low drain-source ON resistance: $RDS(ON) = 16 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 26 \text{ S (typ.)}$
- Low leakage current: $IDSS = 100 \mu A (max) (VDS = 30 V)$
- Enhancement-model: $V_{th} = 1.5 \text{ to } 3.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	30	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	30	V	
Gate-source voltage		V_{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	45	Α	
	Pulse (Note 1)	I _{DP}	135		
Drain power dissipation	n (Tc = 25°C)	P_{D}	100	W	
Single pulse avalanche energy (Note 2)		E _{AS}	220	mJ	
Avalanche current		I _{AR}	45	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	10	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to150	°C	

JEDEC — JEITA SC-65 TOSHIBA 2.0±0.3 1.0±0.3±0.2 0.0±0.3 0.0±

Weight: 4.6 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

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Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 78 μ H, I_{AR} = 45 A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.



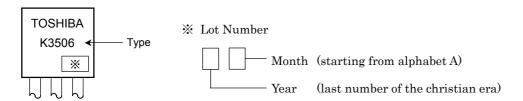
Electrical Characteristics (Ta = 25°C)

Chara	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage curr	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain cut-OFF cui	rrent	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V		_	100	μΑ
Drain-source brea	ıkdown voltage	V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	30	_	_	V
Gate threshold vo	ltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.5	_	3.0	V
Drain-source ON	resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 25 A	_	16	20	mΩ
Forward transfer a	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 25 A	13	26	_	S
Input capacitance		C _{iss}		_	1500	_	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		480		
Output capacitance		C _{oss}		_	680	_	
Switching time	Rise time	t _r	$V_{GS} = 1.2 \Omega$ $V_{GS} = 1.2 \Omega$ $V_{DD} \simeq 30 \text{ V}$ $V_{DD} \simeq 30 \text{ V}$	_	11	_	- ns
	Turn-ON time	t _{on}		_	18	_	
	Fall time	t _f		_	60	_	
	Turn-OFF time	t _{off}		_	130	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	39	_	nC
Gate-source charge		Qgs	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 45 \text{ A}$	_	25	_	
Gate-drain ("miller") charge		Q _{gd}		_	14	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	_	_	_	45	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	135	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 45 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 45 A, V _{GS} = 0 V,	_	100	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 50 A/μs	_	200	_	nC

Marking



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